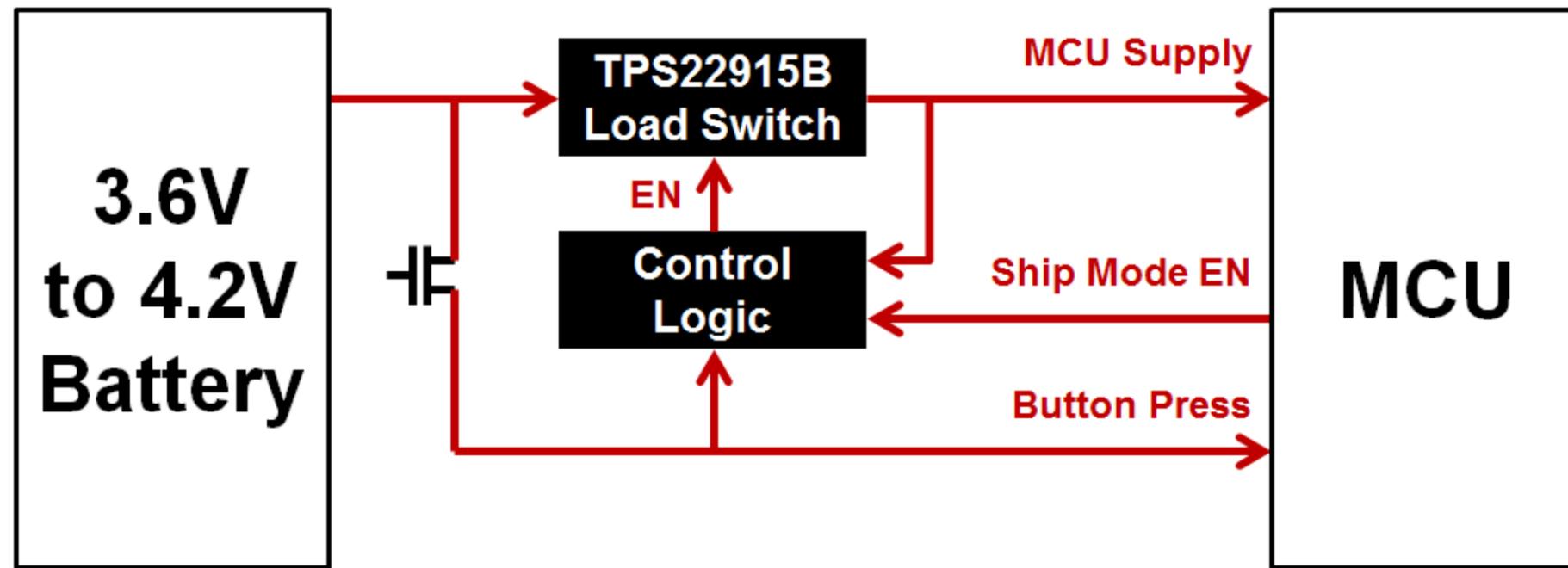


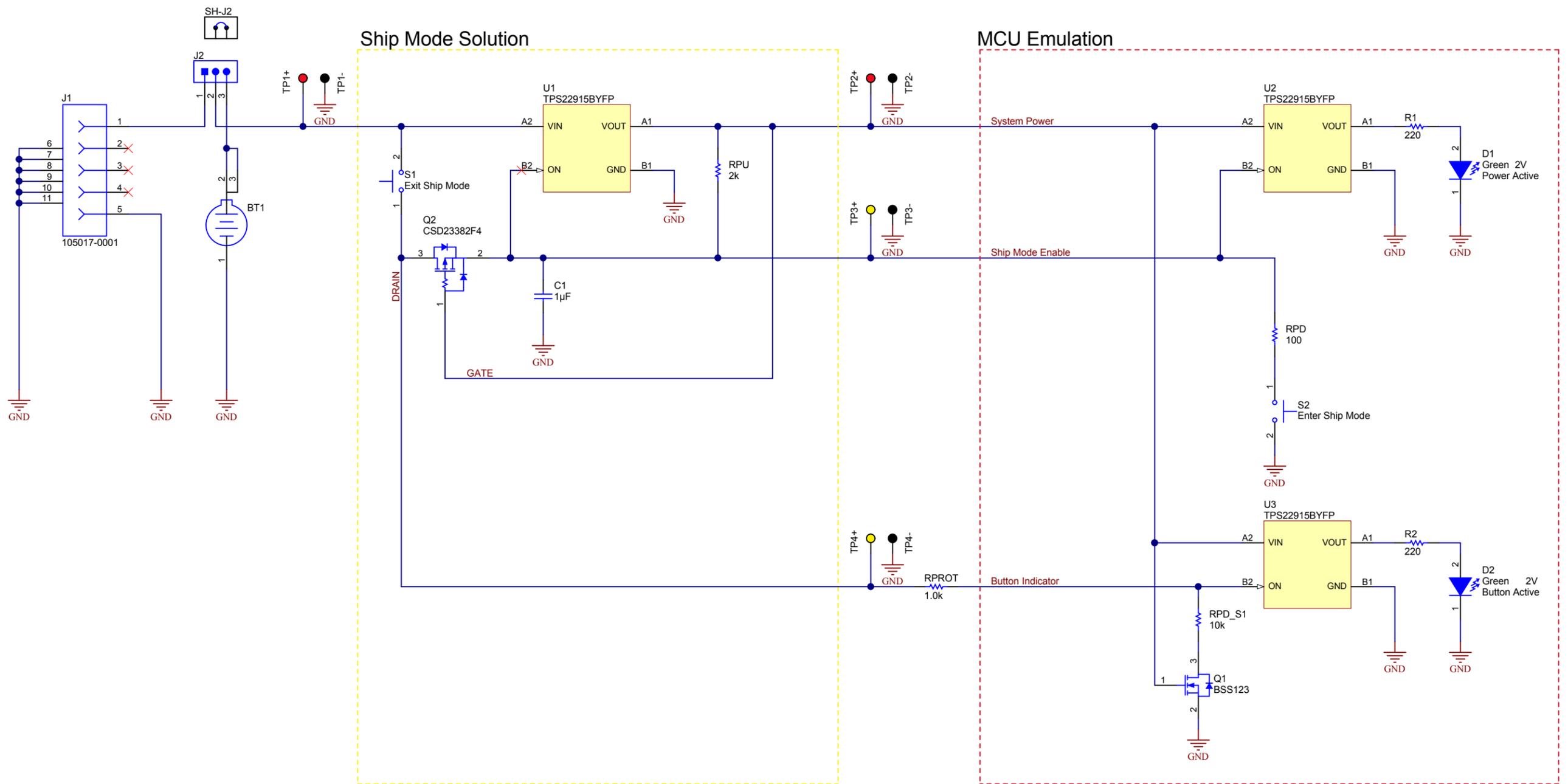
Revision History	
Revision	Notes

TIDA-00556 Ship Mode for Wearables



Orderable: N/A	Designed for: Public Release	Mod. Date: 11/10/2015	 TEXAS INSTRUMENTS http://www.ti.com
TID #: 00556	Project Title: Ship Mode for Wearables	Sheet: 1 of 3	
Number: TIDA-00556	Rev: E2	File: CoverSheet.SchDoc	Size: B
SVN Rev: Version control disabled	Engineer: Brian Lackey	Contact: http://www.ti.com/support	© Texas Instruments 2015

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Orderable: N/A	Designed for: Public Release	Mod. Date: 11/4/2015
TID #: 00556	Project Title: Ship Mode for Wearables	
Number: TIDA-00556	Rev: E2	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By:	File: Ship_Mode_Circuit.SchDoc	Size: B
Engineer: Brian Lackey	Contact: http://www.ti.com/support	





PCB Number: TIDA-00556
PCB Rev: E2

PCB
LOGO
Texas Instruments

PCB
LOGO
Pb-Free Symbol

Label Table	
Variant	Label Text
001	Default Variant

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: N/A	Designed for: Public Release	Mod. Date: 5/21/2015	 TEXAS INSTRUMENTS http://www.ti.com © Texas Instruments 2015
TID #: 00556	Project Title: Ship Mode for Wearables		
Number: TIDA-00556	Rev: E2	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3	
Drawn By: Brian Lackey	File: TID_Hardware.SchDoc	Size: B	
Engineer: Brian Lackey	Contact: http://www.ti.com/support		

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